

Andreas Larsson

List of Publications by Year in descending order

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papers

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2682572

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times ranked

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citing authors

#	ARTICLE	IF	CITATIONS
1	Partially Liquid Interconnects With The Au-Ge System Mechanical Strength and Electrical Resistivity. , 2019, , .		1
2	Off-Eutectic Au-Ge Die-Attach Microstructure, Mechanical Strength, and Electrical Resistivity. IEEE Transactions on Components, Packaging and Manufacturing Technology, 2019, 9, 2465-2475.	2.5	2
3	Effect of Temperature on the Die Shear Strength of a Au-Sn SLID Bond. Metallurgical and Materials Transactions A: Physical Metallurgy and Materials Science, 2013, 44, 2914-2916.	2.2	23
4	Au-Sn SLID Bonding: A Reliable HT Interconnect and Die Attach Technology. Metallurgical and Materials Transactions B: Process Metallurgy and Materials Processing Science, 2013, 44, 406-413.	2.1	35
5	Intermetallic Bonding for High-Temperature Microelectronics and Microsystems: Solid-Liquid Interdiffusion Bonding. , 0, , .		9